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Dimensions

Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.58mm MIN
B	0.45mm +/-0.15mm

Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information

Series	SMD Indust X7R HT175C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, FT-Cap
Features	FT-CAP, High Temperature
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+175°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15% (-55C to 125C), 1kHz 1.0Vrms
Dissipation Factor	3.5% 1kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	5 GOhms